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NPN SILICON GERMANIUM RF TRANSISTOR NESG250134

NPN SiGE RF TRANSISTOR FOR MEDIUM OUTPUT POWER AMPLIFICATION (800 mW) 3-PIN POWER MINIMOLD (34 PACKAGE)

FEATURES

• This product is suitable for medium output power (800 mW) amplification

Po = 29 dBm TYP. @ VoE = 3.6 V, Pin = 15 dBm, f = 460 MHz

Po = 29 dBm TYP. @ Voe = 3.6 V, Pin = 20 dBm, f = 900 MHz

- MSG (Maximum Stable Gain) = 23 dB TYP., @ VcE = 3.6 V, Ic = 100 mA, f = 460 MHz
- Using UHS2-HV process (SiGe technology), Vobo (ABSOLUTE MAXIMUM RATINGS) = 20 V
- 3-pin power minimold (34 package)

ORDERING INFORMATION

Part Number	Quantity	Supplying Form	
NESG250134-A	25 pcs (Non reel)	• 12 mm wide embossed taping	
NESG250134-T1-A	1 kpcs/reel	Pin 2 (Emitter) face the perforation side of the tape	

Remark To order evaluation samples, contact your nearby sales office. Unit sample quantity is 25 pcs.

ABSOLUTE MAXIMUM RATINGS ($T_A = +25$ °C)

Parameter	Symbol	Ratings	Unit
Collector to Base Voltage	Vсво	20	V
Collector to Emitter Voltage	VCEO	9.2	V
Emitter to Base Voltage	V _{EBO}	2.8	V
Collector Current	lc	500	mA
Total Power Dissipation	P _{tot} Note	1.5	W
Junction Temperature	Tj	150	°C
Storage Temperature	T _{stg}	-65 to +150	°C

Note Mounted on 34.2 cm² × 0.8 mm (t) glass epoxy PWB

Caution: Observe precautions when handling because these devices are sensitive to electrostatic discharge

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THERMAL RESISTANCE (TA = +25°C)

Parameter	Symbol	Ratings	Unit
Termal Resistance from Junction to Ambient Note	Rth _{j-a}	80	°C/W

Note Mounted on $34.2 \text{ cm}^2 \times 0.8 \text{ mm}$ (t) glass epoxy PWB

RECOMMENDED OPERATING RANGE (TA = +25°C)

Parameter	Symbol	MIN.	TYP.	MAX.	Unit
Collector to Emitter Voltage	Vce	-	3.6	4.5	٧
Collector Current	lc	-	400	500	mA
Input Power Note	Pin	_	12	17	dBm

Note Input power under conditions of $V_{\text{CE}} \le 4.5 \text{ V}, \, f = 460 \text{ MHz}$

ELECTRICAL CHARACTERISTICS (TA = +25°C)

Parameter	Symbol	Test Conditions	MIN.	TYP.	MAX.	Unit
DC Characteristics						
Collector Cut-off Current	Ісво	VcB = 5 V, IE = 0 mA	-	-	1	μΑ
Emitter Cut-off Current	ІЕВО	VEB = 0.5 V, Ic = 0 mA	-	-	1	μΑ
DC Current Gain	hfe Note 1	Vce = 3 V, Ic = 100 mA	80	120	180	-
RF Characteristics						
Gain Bandwidth Product	f⊤	Vce = 3.6 V, Ic = 100 mA, f = 460 MHz	=	10	=	GHz
Insertion Power Gain	S _{21e} ²	Vce = 3.6 V, Ic = 100 mA, f = 460 MHz	=	19	=	dB
Maximum Satble Gain	MSG Note	V _{CE} = 3.6 V, I _C = 100 mA, f = 460 MHz	-	23	-	dB
Linner gain (1)	GL	$V_{\text{CE}} = 3.6 \text{ V}, \text{ Ic (set)} = 30 \text{ mA (RF OFF)},$ $f = 460 \text{ MHz}, \text{ Pin} = 0 \text{ dBm}$	16	19	-	dB
Linner gain (2)	GL	$\begin{split} \text{VCE} &= 3.6 \text{ V}, \text{ Ic (set)} = 30 \text{ mA (RF OFF)}, \\ \text{f} &= 900 \text{ MHz}, \text{ Pin} = 0 \text{ dBm} \end{split}$	-	16	=	dB
Output Power (1)	Ро	$\begin{split} \text{V}_{\text{CE}} = 3.6 \text{ V}, \text{ Ic (set)} = 30 \text{ mA (RF OFF)}, \\ \text{f} = 460 \text{ MHz}, \text{P}_{\text{in}} = 15 \text{ dBm} \end{split}$	27	29	-	dBm
Output Power (2)	Ро	$\begin{split} \text{V}_{\text{CE}} = 3.6 \text{ V, Ic (set)} = 30 \text{ mA (RF OFF)}, \\ \text{f} = 900 \text{ MHz, Pin} = 20 \text{ dBm} \end{split}$	_	29	-	dBm
Collector Efficiency (1)	η c	$\begin{split} \text{V}_{\text{CE}} = 3.6 \text{ V}, \text{ Ic (set)} = 30 \text{ mA (RF OFF)}, \\ \text{f} = 460 \text{ MHz}, \text{Pin} = 15 \text{ dBm} \end{split}$	_	60	_	%
Collector Efficiency (2)	η c	$\begin{split} \text{V}_{\text{CE}} &= 3.6 \text{ V}, \text{ Ic (set)} = 30 \text{ mA (RF OFF)}, \\ \text{f} &= 900 \text{ MHz}, \text{Pin} = 20 \text{ dBm} \end{split}$	-	60	_	%

Notes 1. Pulse measurement: PW $\leq 350~\mu\text{s}, \text{ Duty Cycle} \leq 2\%$

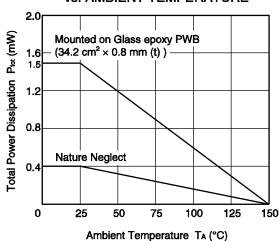
2. MSG =
$$\frac{S_{21}}{S_{12}}$$

hfe CLASSIFICATION

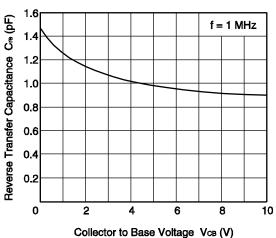
Rank	FB	
Marking	SN	
h _{FE} Value	80 to 180	

■ TYPICAL CHARACTERISTICS (TA = +25°C, unless otherwise specified)

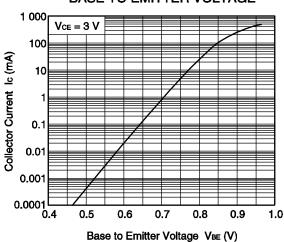




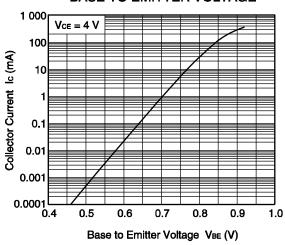
REVERSE TRANSFER CAPACITANCE vs. COLLECTOR TO BASE VOLTAGE



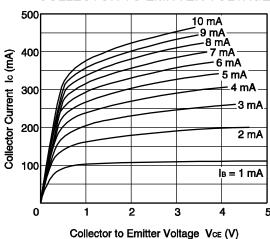
COLLECTOR CURRENT vs. BASE TO EMITTER VOLTAGE



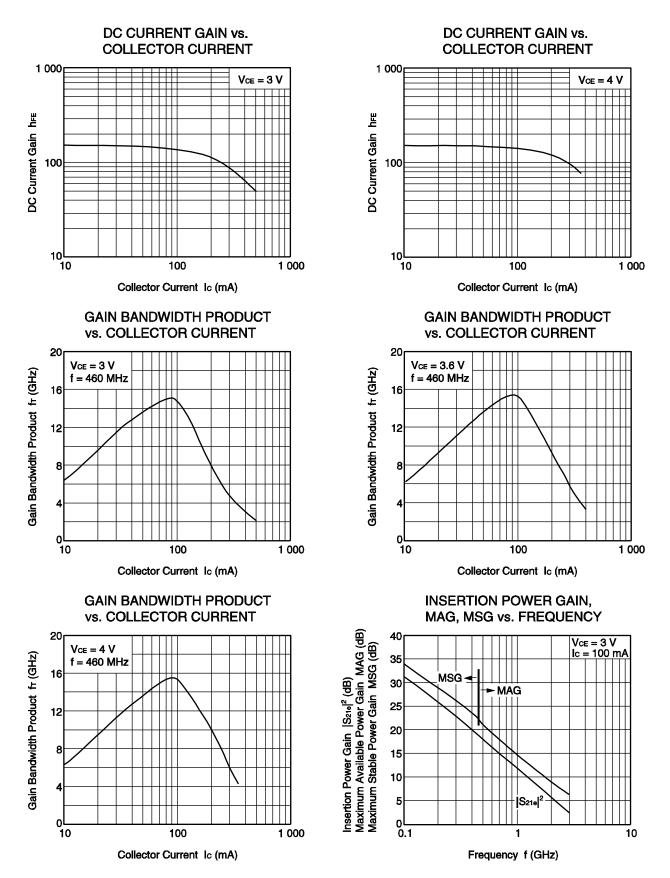
COLLECTOR CURRENT vs.
BASE TO EMITTER VOLTAGE



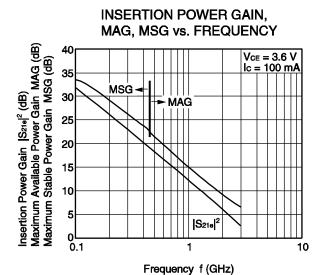
COLLECTOR CURRENT vs. COLLECTOR TO EMITTER VOLTAGE



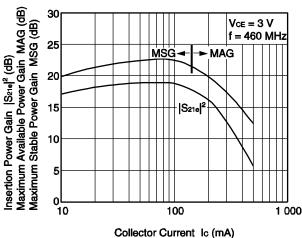
Remark The graphs indicate nominal characteristics.



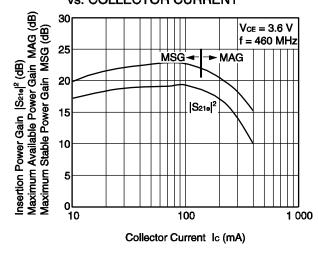
Remark The graphs indicate nominal characteristics.





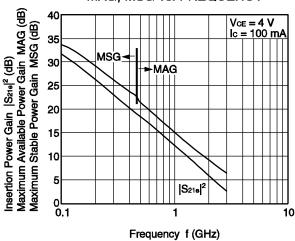


INSERTION POWER GAIN, MAG, MSG vs. COLLECTOR CURRENT

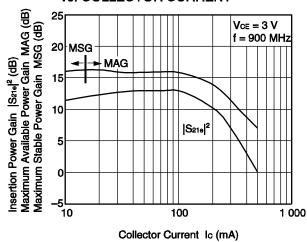


Remark The graphs indicate nominal characteristics.

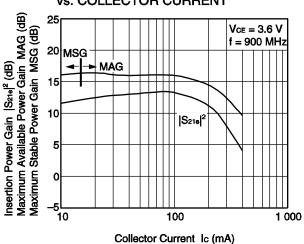
INSERTION POWER GAIN, MAG, MSG vs. FREQUENCY

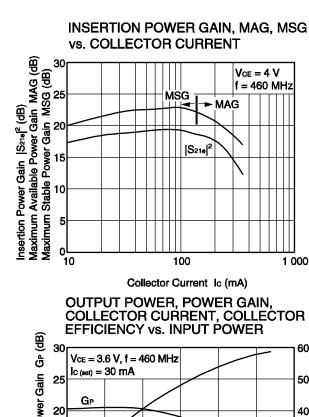


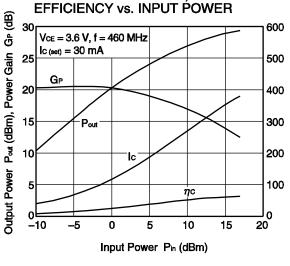
INSERTION POWER GAIN, MAG, MSG vs. COLLECTOR CURRENT

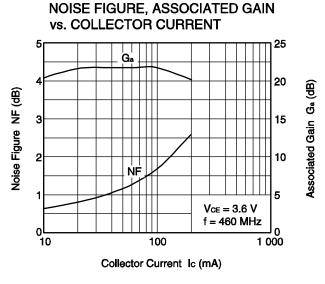


INSERTION POWER GAIN, MAG, MSG vs. COLLECTOR CURRENT

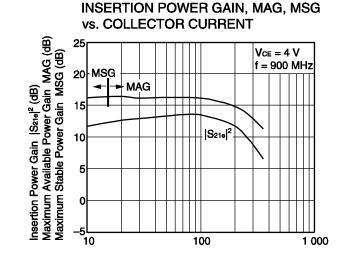


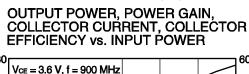




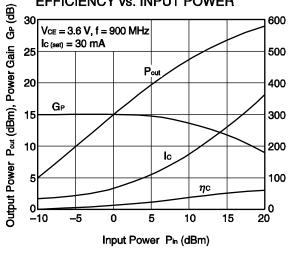


Remark The graphs indicate nominal characteristics.





Collector Current Ic (mA)

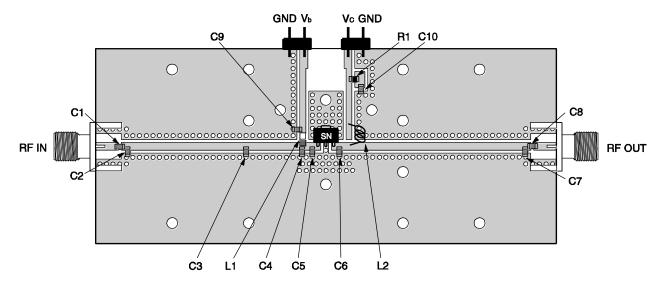


Collector Current Ic (mA), Collector Efficiency $\eta_{
m c}$ (%)

nc (%)

Collector Current Ic (mA), Collector Efficiency

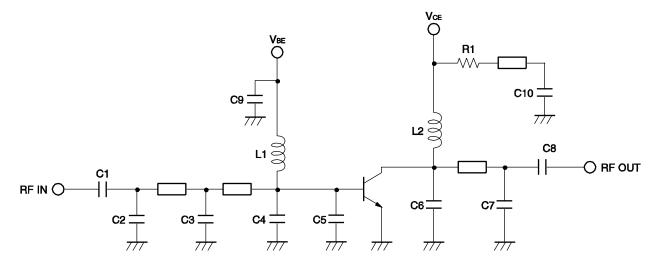
■ PA EVALUATION BOARD (f = 460 MHz)



Notes

- 1. 38×90 mm, t = 0.8 mm double sided copper clad glass epoxy PWB.
- 2. Back side: GND pattern
- 3. Solder gold plated on pattern
- 4. ∘ O: Through holes

PA EVALUATION CIRCUIT (f = 460 MHz)

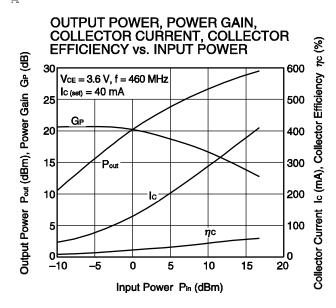


The application circuits and their parameters are for reference only and are not intended for use in actual design-ins.

COMPONENT LIST

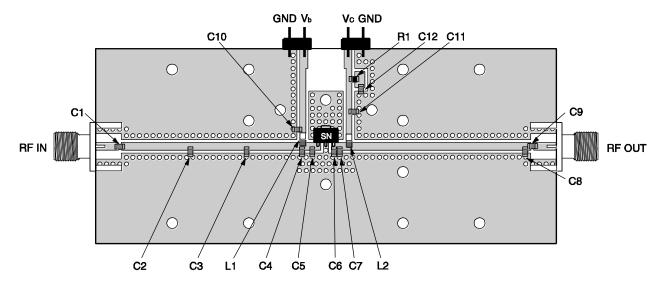
	Value	Maker
C1	30 pF	Murata
C2	6 pF	Murata
C3, C4	7 pF	Murata
C5	3 pF	Murata
C6	0.5 pF	Murata
C7	5 pF	Murata
C8	10 pF	Murata
C9, C10	100 nF	Murata
L1	100 nH	Toko
L2	3 nH	Toko
R1	30 Ω	SSM

PA EVALUATION CIRCUIT TYPICAL CHARACTERISTICS



Remark The graph indicates nominal characteristics.

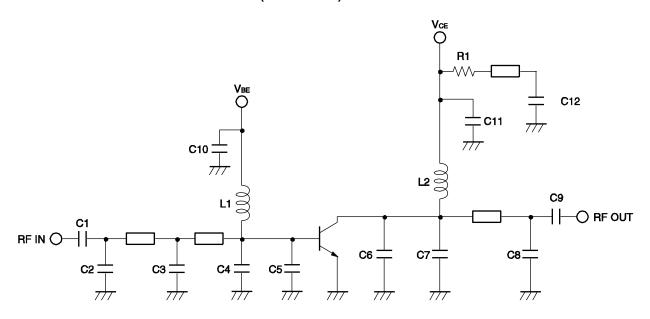
■ DISTORTION EVALUATION BOARD (f = 460 MHz)



Notes

- 1. 38×90 mm, t = 0.8 mm, double sided copper clad glass epoxy PWB.
- 2. Back side: GND pattern
- 3. Solder gold plated on pattern
- 4. ∘ O: Through holes

■ DISTORTION EVALUATION CIRCUIT (f = 460 MHz)



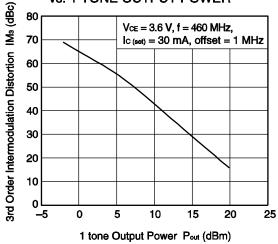
The application circuits and their parameters are for reference only and are not intended for use in actual design-ins.

COMPONENT LIST

	Value	Maker
C1	47 pF	Murata
C2	12 pF	Murata
C3, C4	7 pF	Murata
C5	3 pF	Murata
C6	6 pF	Murata
C7	0.5 pF	Murata
C8	5 pF	Murata
C9	51 pF	Murata
C10, C12	100 nF	Murata
C11	1 <i>μ</i> F	Murata
L1	100 nH	Toko
L2	15 nH	Toko
R1	30 Ω	SSM

DISTORTION EVALUATION CIRCUIT TYPICAL CHARACTERISTICS

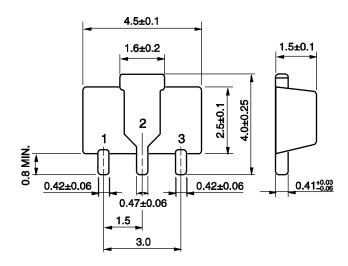




Remark The graph indicates nominal characteristics.

PACKAGE DIMENSIONS

3-PIN POWER MINIMOLD (34 PACKAGE) (UNIT: mm)



PIN CONNECTIONS

- 1. Collector
- 2. Emitter
- 3. Base

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